

PALM INTRANET

Day : Thursday
Date: 12/4/2003
Time: 13:12:26

Inventor Name Search Result

Your Search was:

Last Name = TSAI

First Name = CHENG-YUAN

Application#	Patent#	Status	Date Filed	Title	Inventor Name 39
29173033	Not Issued	093	12/23/2002	LIGHT ? , NO	TSAI, CHENG-YUAN
10248749	6653204	150	02/14/2003	METHOD OF FORMING A SHALLOW TRENCH ISOLATION STRUCTURE ?	TSAI, CHENG-YUAN
10084398 2003015965	Not Issued	041 NR	02/25/2002	HEATING INJECTION APPARATUS FOR VAPOR LIQUID DELIVERY SYSTEM NO	TSAI, CHENG-YUAN
10063896 this case	Not Issued	030	05/22/2002	METHOD OF ENHANCING ADHESION STRENGTH OF BSG FILM TO SILICON NITRIDE FILM	TSAI, CHENG-YUAN
09931016 20030036296	Not Issued	061 2820	08/17/2001	METHOD FOR IMPROVING THE COATING * CAPABILITY OF LOW-K DIELECTRIC LAYER 438/782	TSAI, CHENG-YUAN
09886769	6599826	150	06/19/2001	METHOD FOR FABRICATING A LOW DIELECTRIC CONSTANT MATERIAL LAYER	TSAI, CHENG-YUAN
09855855	Not Issued	168 and	05/15/2001	METHOD FOR MANUFACTURING A DUAL DAMASCENE STRUCTURE	TSAI, CHENG-YUAN
09847407	Not Issued	161 w/bul	05/02/2001	METHOD FOR IMPROVING ADHESION OF LOW K MATERIALS WITH ADJACENT LAYER	TSAI, CHENG-YUAN
09835280	Not Issued	161	04/13/2001	METHOF FOR FORMING DIELECTRIC OF LOW DIELECTRIC CONSTANT ON HYDROPHILIC DIELECTRIC AND THE STRUCTURE	TSAI, CHENG-YUAN
09828368	6383913	150	04/06/2001	METHOD FOR IMPROVING SURFACE WETTABILITY OF LOW K MATERIAL	TSAI, CHENG-YUAN
09823112	Not Issued	161	03/31/2001	METHOD FOR IMPROVING LOW K MATERIAL SURFACE STABILITY	TSAI, CHENG-YUAN
09814410	Not Issued	161	03/22/2001	METHOD FOR STABILIZING LOW DIELECTRIC CONSTANT LAYER	TSAI, CHENG-YUAN
09801330 damaged	6429113	150	03/07/2001	METHOD OF MANUFACTURING MULTILEVEL INTERCONNECTS INCLUDING PERFORMING A SURFACE TREATMENT TO FORM A HYDROPHILIC SURFACE LAYER	TSAI, CHENG-YUAN
09790945	Not Issued	161	02/22/2001	METHOD FOR FORMING AN INTER-METAL DIELECTRIC LAYER	TSAI, CHENG-YUAN
09790192	6486079	150	02/21/2001	METHOD FOR STABILIZING LOW DIELECTRIC CONSTANT MATERIALS	TSAI, CHENG-YUAN
09789349	6554002	150	02/21/2001	METHOD FOR REMOVING ETCHING RESIDUES	TSAI, CHENG-YUAN
09759570	6410106	150	01/11/2001	METHOD OF FORMING AN INTERMETAL DIELECTRIC LAYER	TSAI, CHENG-YUAN
09715657 no pre-pub	Not Issued	095 allow / not ifw	11/17/2000	METHOD FOR INCREASING ADHESION ABILITY OF DIELECTRIC MATERIAL IN SEMICONDUCTOR	TSAI, CHENG-YUAN
09685430	6365228	150	10/10/2000	PROCESS FOR SPIN-ON COATING WITH AN ORGANIC MATERIAL HAVING A LOW DIELECTRIC CONSTANT	TSAI, CHENG-YUAN

Products

<i>Wu</i>	09683245 <i>2003010244</i>	Not Issued	095 <i>all</i>	12/05/2001	BILAYER SILICON CARBIDE BASED BARRIER	TSAI, CHENG-YUAN
	09682940	Not Issued	161	11/02/2001	OXYGEN-DOPED SILICON CARBIDE ETCH STOP LAYER	TSAI, CHENG-YUAN
<i>pull</i>	09682822	6521545	130	10/23/2001	METHOD OF A SURFACE TREATMENT ON A FLUORINATED SILICATE GLASS FILM <i>O-plasma</i>	TSAI, CHENG-YUAN
<i>#Wu</i>	09682307	6521300	150	08/16/2001 <i>1235703</i>	METHOD OF A SURFACE TREATMENT IN IMPROVING ADHESION OF AN ORGANIC POLYMERIC LOW-K DIELECTRIC LAYER <i>O-plasma on (Si₃N₄)</i>	TSAI, CHENG-YUAN
	09682213	Not Issued	161	08/07/2001	METHOD OF IMPROVING RELIABILITY OF A DUAL DAMASCENE INTERCONNECTION	TSAI, CHENG-YUAN
<i>V</i>	09655957	6323123	150	09/06/2000	LOW-K DUAL DAMASCENE INTEGRATION PROCESS <i>Hyd - no O-plasma rich</i>	TSAI, CHENG-YUAN
	09639982	Not Issued	161	08/17/2000	METHOD OF FORMING AN INTERLEVEL DIELECTRIC (ILD)	TSAI, CHENG-YUAN
<i>poor</i>	09617458	6376394	150	07/17/2000	METHOD OF FORMING INTER-METAL DIELECTRIC LAYER <i>FSG</i>	TSAI, CHENG-YUAN
<i>pull</i>	09531974	6410446	150	03/20/2000	METHOD FOR GAP FILLING	TSAI, CHENG-YUAN
<i>NO</i>	09477111	6197681	150	12/31/1999	FORMING COPPER INTERCONNECTS IN DIELECTRIC MATERIALS WITH LOW CONSTANT DIELECTRICS	TSAI, CHENG-YUAN
<i>NO</i>	09471055	6200653	150	12/22/1999	METHOD OF FORMING AN INTERMETAL DIELECTRIC LAYER <i>PROD ready, but no O-plasma treat</i>	TSAI, CHENG-YUAN
	09469501	Not Issued	161	12/22/1999	METHOD FOR ELIMINATING THE SURFACE SENSITIVITY IN AP-OZONE/TEOS CHEMICAL VAPOR DEPOSITION	TSAI, CHENG-YUAN
	09435724	Not Issued	161	11/08/1999	APPARATUS FOR AVOIDING PLASMA DAMAGE ON A WAFER	TSAI, CHENG-YUAN
<i>pull</i>	09417830	6319814	150	10/12/1999	METHOD OF FABRICATING DUAL DAMASCENE WHEREIN THE IMD LAYER COMPRISES FSG FORMED OVER A USG LINER	TSAI, CHENG-YUAN
	09415798	6174793	150	10/11/1999	METHOD FOR ENHANCING ADHESION BETWEEN COPPER AND SILICON NITRIDE	TSAI, CHENG-YUAN
<i>NO</i>	09391357	6261977	150	09/08/1999	METHOD FOR PREVENTING AN ELECTROSTATIC CHUCK FROM BEING CORRODED DURING A CLEANING PROCESS	TSAI, CHENG-YUAN
	09373756	Not Issued	161	08/13/1999	METHOD FOR PREVENTING THE FORMATION OF VOIDS IN A SILICON OXIDE LAYER OF A SEMICONDUCTOR WAFER	TSAI, CHENG-YUAN
<i>poor - pull</i>	09348884	6146974	150	07/01/1999	METHOD OF FABRICATING SHALLOW TRENCH ISOLATION (STI) <i>PROD</i>	TSAI, CHENG-YUAN
<i>fixed</i>	09314928	6001746	150	05/20/1999	METHOD OF FORMING AN UNDOPED SILICATE GLASS LAYER ON A SEMICONDUCTOR WAFER <i>PROD undoped Silicate glass</i>	TSAI, CHENG-YUAN
<i>NO</i>	09241841	6218284	150	02/01/1999	METHOD FOR FORMING AN INTER-METAL DIELECTRIC LAYER	TSAI, CHENG-YUAN

Inventor Search Completed: No Records to Display.

Last Name		First Name	
Search Another: Inventor	<input type="text" value="tsai"/>	<input type="text" value="cheng-yuan"/>	<input type="button" value="Search"/>

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PALM INTRANET

Day : Thursday
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Inventor Name Search Result

Your Search was:

Last Name = WU

First Name = HSIN-CHANG

Application#	Patent#	Status	Date Filed	Title	Inventor Name 5
10248749	6653204	150	02/14/2003	METHOD OF FORMING A SHALLOW TRENCH ISOLATION STRUCTURE	WU, HSIN-CHANG
10063896	Not Issued	030	05/22/2002	METHOD OF ENHANCING ADHESION STRENGTH OF BSG FILM TO SILICON NITRIDE FILM	WU, HSIN-CHANG
09683245	Not Issued	095	12/05/2001	BILAYER SILICON CARBIDE BASED BARRIER	WU, HSIN-CHANG
09682940	Not Issued	161	11/02/2001	OXYGEN-DOPED SILICON CARBIDE ETCH STOP LAYER	WU, HSIN-CHANG
09682307	6521300	150	08/16/2001	METHOD OF A SURFACE TREATMENT IN IMPROVING ADHESION OF AN ORGANIC POLYMERIC LOW-K DIELECTRIC LAYER	WU, HSIN-CHANG

Inventor Search Completed: No Records to Display.

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PALM INTRANET

Day : Thursday
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Inventor Name Search Result

Your Search was:

Last Name = FANG

First Name = YU-WEN

IFW

Application#	Patent#	Status	Date Filed	Title	Inventor Name 2
10264517	Not Issued	030 1705	10/05/2002 438/8.	METHOD FOR RECOVERING A PLASMA PROCESS	FANG, YU-WEN
10063896 this	Not Issued	030	05/22/2002	METHOD OF ENHANCING ADHESION STRENGTH OF BSG FILM TO SILICON NITRIDE FILM	FANG, YU-WEN

NC

Inventor Search Completed: No Records to Display.

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PALM INTRANET

Day : Thursday
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Inventor Name Search Result

Your Search was:

Last Name = YANG

First Name = NENG-HUI

Application#	Patent#	Status	Date Filed	Title	Inventor Name 14
10604741	Not Issued	020	08/14/2003	MOS TRANSISTOR HAVING REDUCED SOURCE/DRAIN EXTENSION SHEET RESISTANCE	YANG, NENG-HUI <i>all prod</i>
10248749	6653204	150	02/14/2003	METHOD OF FORMING A SHALLOW TRENCH ISOLATION STRUCTURE	YANG, NENG-HUI
10105313 <i>20030183508</i>	Not Issued	030	03/26/2002	METHOD FOR ELECTROPLATED METAL ANNEALING PROCESS	YANG, NENG-HUI
10084398	Not Issued	041	02/25/2002	HEATING INJECTION APPARATUS FOR VAPOR LIQUID DELIVERY SYSTEM	YANG, NENG-HUI
10063896 <i>this</i>	Not Issued	030	05/22/2002	METHOD OF ENHANCING ADHESION STRENGTH OF BSG FILM TO SILICON NITRIDE FILM	YANG, NENG-HUI
09885043	6429152	150	06/21/2001	METHOD OF FORMING A THIN FILM ON A SEMICONDUCTOR WAFER	YANG, NENG-HUI
09829220	Not Issued	161	04/09/2001	SURFACE DENSIFICATION OF LOW DIELECTRIC CONSTANT FILM	YANG, NENG-HUI
09798244	6596652	150	03/06/2001	METHOD OF FABRICATING LOW DIELECTRIC CONSTANT FILM	YANG, NENG-HUI
09721147	6387813	150	11/22/2000	METHOD FOR STRIPPING A LOW DIELECTRIC FILM WITH HIGH CARBON CONTENT	YANG, NENG-HUI
09715420	6406978	150	11/18/2000	METHOD OF REMOVING SILICON CARBIDE	YANG, NENG-HUI
09684498	6365527	150	10/06/2000	METHOD FOR DEPOSITING SILICON CARBIDE IN SEMICONDUCTOR DEVICES	YANG, NENG-HUI
09683245	Not Issued	095	12/05/2001	BILAYER SILICON CARBIDE BASED BARRIER	YANG, NENG-HUI
09682940	Not Issued	161	11/02/2001	OXYGEN-DOPED SILICON CARBIDE ETCH STOP LAYER	YANG, NENG-HUI
09682822	6521545	150	10/23/2001	METHOD OF A SURFACE TREATMENT ON A FLUORINATED SILICATE GLASS FILM	YANG, NENG-HUI

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